PRODUCT DATASHEET

TELID[®] RFID Sensors

TELID[®] 211.03 preliminary

RFID temperature transponder 13.56MHz

- passive pressure measurement transponder
- sensor window on top side
- non flexible hard TAG, package D14
- contactless data communication ISO 15693

RFID Sensor TELID® devices are an integral part of microsensys iID® system solution. These devices are very useful for wireless sensors applications in industrial solutions, for quality check in food and pharma industry, for temperature check in maintenance processes and transport and logistics. TELIDs are operating optimal with microsensys standard RFID reader.



TELID211.03-001

| RFID Technology: Chip Type: Carrier Frequency: Communication Rate: Communication Distar | RFID system TELID [®] 200 iID-MA 13.56 MHz 26,48 kbps ce: 0 30 mm | iID [®] 2000 based on ISO 15693 closed coupling HF sensor solution depending on reader antenna and environmental conditions |
|---|---|--|
| Data Memory: Static Memory: Memory: | EEPROM read v 4kbit | vrite type endurance >100000 cycles, data retention > 10 years TID, parameters, calibration data, manufacturer OTP 3.5kbit for free usages |
| Temperature Sensor: Working Range: Resolution: Accuracy: Thermal Time Constant: | semiconductor sensor -40°C +125°C 0.0625°K +/- 0.5°K +/- 1.0 K | parameter of integrated device only sensor, not for total device at 0°C +65°C at -40°C +125°C depending on mounting technology |
| Operating Mode: Measure Modes: Basic Functions: Parameters: | PASSIVE SENSOR AD HOC MEASUREMENT read/write memo | in reader RF field ry, get sensor value calibration data (optional) |
| Battery: | no battery | |
| Working Temperature: Storage Temperature: | -25°C +85°C -40°C +125°C | maximum range |
| Dimensions: Packaging: | D 14 mm, max. TH 2.0 mm | epoxy glass fiber enforced (black) thermal contact on back side |
| Marking: Mounting / Using Instr | uction: | laser printed on top direct using on metal only with type .550 possible |
| Appropriate RFID Reader: | M30-HEAD reader PEN reader POCKETwork UNI13 module diverse customized modules | with RS232TTL or USB with RS232TTL, USB or Bluetooth with Bluetooth OEM product s for CASIO and PSION industrial handheld |
| Software: iID driver engine, iID DEMOsoft for PC / X86/X64 (for mobile devices on inquiry) | | soft for PC / X86/X64 (for mobile devices on inquiry) |
| Type : Package: Memory Capacity: | 12.211.102 12.211.102 epoxy, half lens epoxy lens 4k 4k | 12.211.102 epoxy on metal 4k bit |

© microsensys, mic3, iID and TELID are registered trademarks or trademarks of microsensys GmbH. Other products mentioned in this document may be trademarks of microsensys or trademarks or registered trademarks of other software, hardware, or service providers and are used herein for identification purposes only. Windows and the Windows Logo are trademarks or registered trademarks of Microsoft Corporation in the United States and/or other countries.